MOSFET – Power, N-Channel, SUPERFET[®] III, Automotive, Easy-drive 650 V, 24 A, 125 mΩ

NVB125N65S3

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- AEC-Q101 Qualified
- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 105 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 46 \text{ nC}$)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 439 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

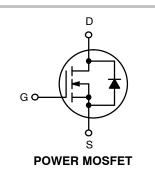
- Automotive On Board Charger
- Automotive DC/DC Converter for HEV



ON Semiconductor®

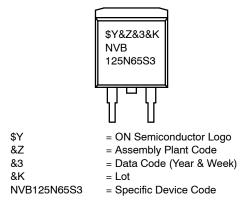
www.onsemi.com

| V _{DSS} | R _{DS(ON)} MAX | I _D MAX | | |
|------------------|-------------------------|--------------------|--|--|
| 650 V | 125 m Ω @ 10 V | 24 A | | |





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

| Symbol | Parameter | Value | Unit | |
|----------------------|--|---|-------------|------|
| V _{DSS} | Drain to Source Voltage | | 650 | V |
| V _{GSS} | Gate to Source Voltage | – DC | ±30 | V |
| | | – AC (f > 1 Hz) | ±30 | |
| ID | Drain Current | – Continuous (T _C = 25°C) | 24 | А |
| | | – Continuous (T _C = 100°C) | 15 | |
| I _{DM} | Drain Current | – Pulsed (Note 1) | 60 | А |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | Single Pulsed Avalanche Energy (Note 2) | | |
| I _{AS} | Avalanche Current (Note 2) | 3.7 | А | |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 1.81 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 20 | |
| PD | Power Dissipation | (T _C = 25°C) | 181 | W |
| | | – Derate Above 25°C | 1.45 | W/°C |
| TJ, T _{STG} | Operating and Storage Temperature Range | | –55 to +150 | °C |
| ΤL | Maximum Lead Temperature for Soldering, 1/8" | 300 | °C | |

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 3.7 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} \le 12 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|-----------------|---|-------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.69 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | |

PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Marking | Package | Reel Size | Tape Width | Shipping [†] |
|-------------|-------------|---------------------|-----------|------------|-----------------------|
| NVB125N65S3 | NVB125N65S3 | D ² -PAK | 330 mm | 24 mm | 800 / Tape & Reel |

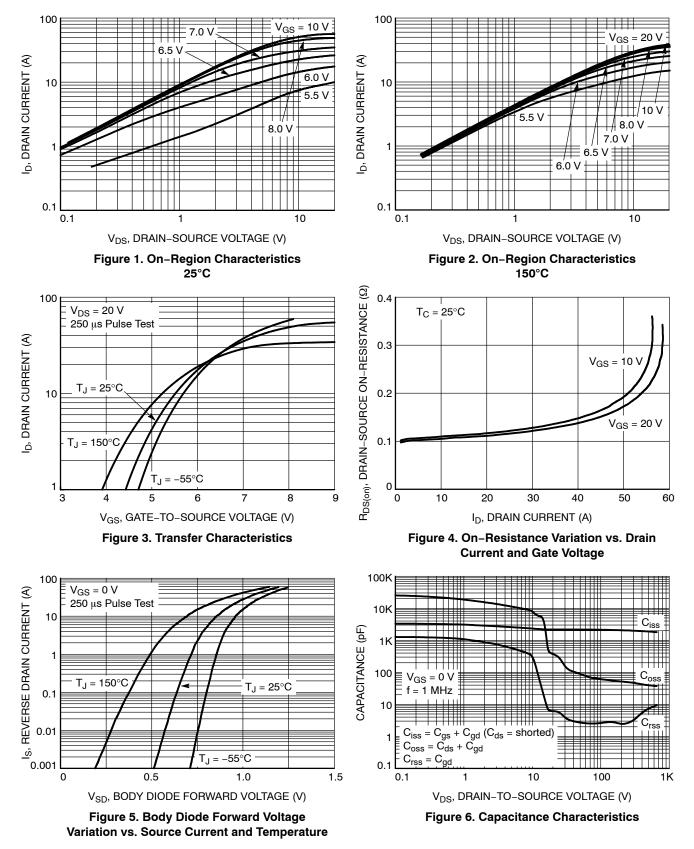
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

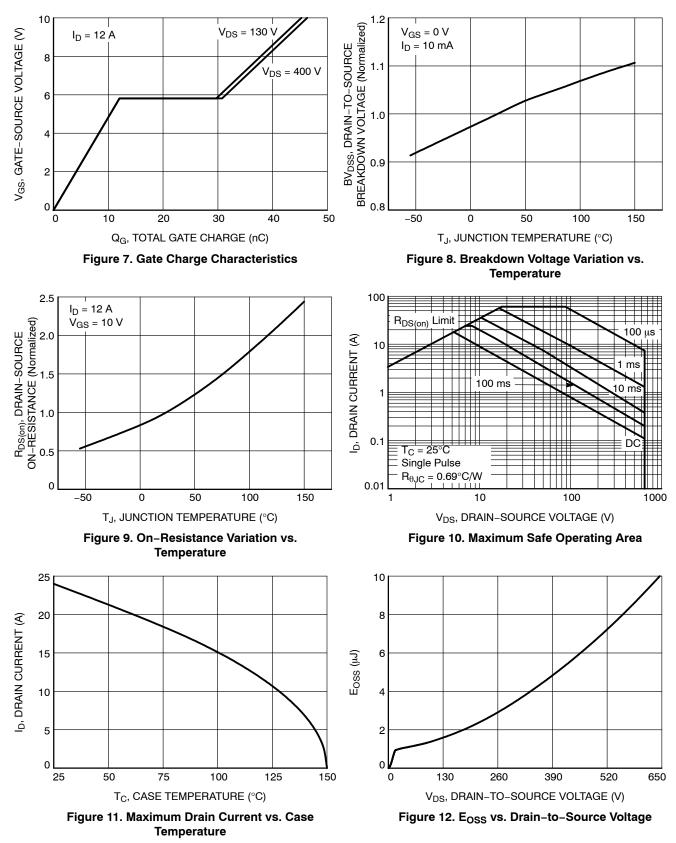
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|--|--|------|------|------|------|
| OFF CHARACT | ERISTICS | • | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C | 650 | | | V |
| | | V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 150°C | 700 | | | V |
| $\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 1 \text{ mA}$, Referenced to 25°C | | 0.68 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μA |
| | | V_{DS} = 520 V, T_{C} = 125°C | | 1.35 | | |
| I _{GSS} | Gate to Body Leakage Current | V_{GS} = ± 30 V, V_{DS} = 0 V | | | ±100 | nA |
| ON CHARACTE | RISTICS | - | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_D = 0.59 \text{ mA}$ | 2.5 | | 4.5 | V |
| R _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = 10 V, I _D = 12 A | | 105 | 125 | mΩ |
| 9 _{FS} | Forward Transconductance | V _{DS} = 20 V, I _D = 12 A | | 16 | | S |
| DYNAMIC CHAI | RACTERISTICS | • | • | | • | |
| C _{iss} | Input Capacitance | V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz | | 1940 | | pF |
| C _{oss} | Output Capacitance | | | 40 | | pF |
| C _{oss(eff.)} | Effective Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | | 439 | | pF |
| C _{oss(er.)} | Energy Related Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | | 62 | | pF |
| Q _{g(tot)} | Total Gate Charge at 10 V | V _{DS} = 400 V, I _D = 12 A, V _{GS} = 10 V (Note 4) | | 46 | | nC |
| Q _{gs} | Gate to Source Gate Charge | | | 12 | | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | 19 | | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | | 0.5 | | Ω |
| WITCHING CH | IARACTERISTICS | - | | | | |
| t _{d(on)} | Turn-On Delay Time | $V_{DD} = 400 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ | | 21 | | ns |
| t _r | Turn-On Rise Time | R _g = 4.7 Ω (Note 4) | | 19 | | ns |
| t _{d(off)} | Turn-Off Delay Time | | | 48 | | ns |
| t _f | Turn-Off Fall Time | | | 4.6 | | ns |
| SOURCE-DRAII | N DIODE CHARACTERISTICS | | - | - | - | - |
| ا _S | Maximum Continuous Source to Drain Diode Forward Current | | | | 24 | Α |
| I _{SM} | Maximum Pulsed Source to Drain Diode Forward Current | | 1 | 1 | 60 | А |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_{SD} = 12 A$ | | | 1.2 | V |
| t _{rr} | Reverse Recovery Time | V _{DD} = 400 V, I _{SD} = 12 A, | | 339 | | ns |
| Q _{rr} | Reverse Recovery Charge | dI _F /dt = 100 A/µs | | 5.7 | 1 | μC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS







TYPICAL CHARACTERISTICS

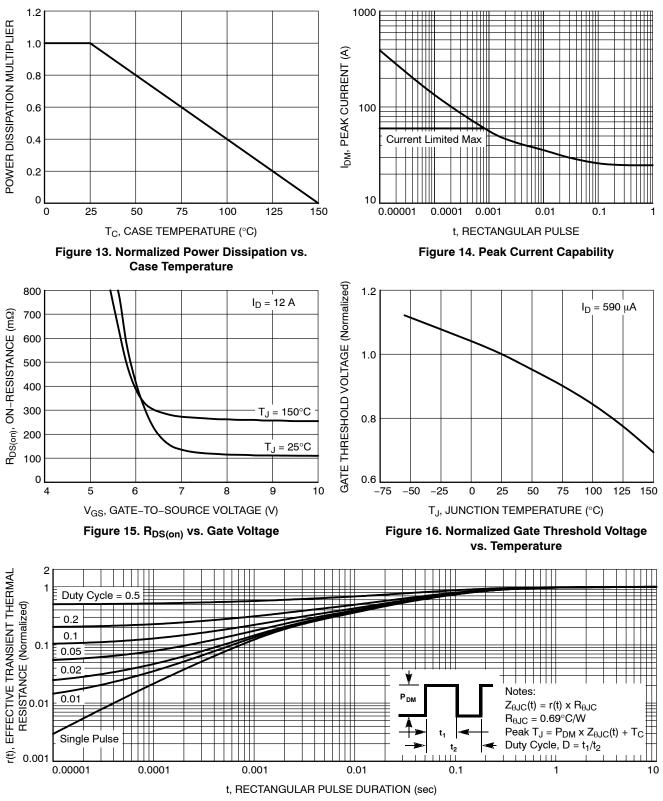
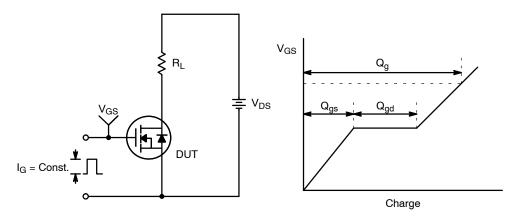


Figure 17. Transient Thermal Response





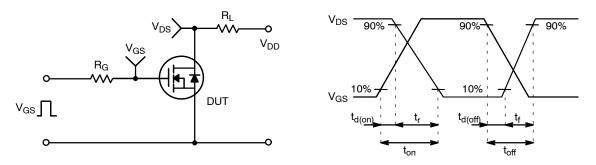
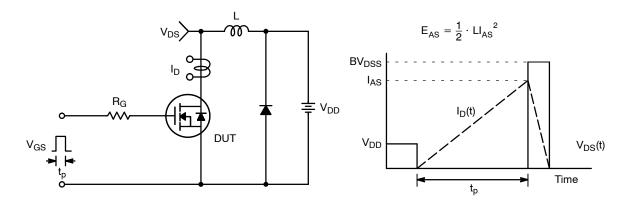


Figure 19. Resistive Switching Test Circuit & Waveforms





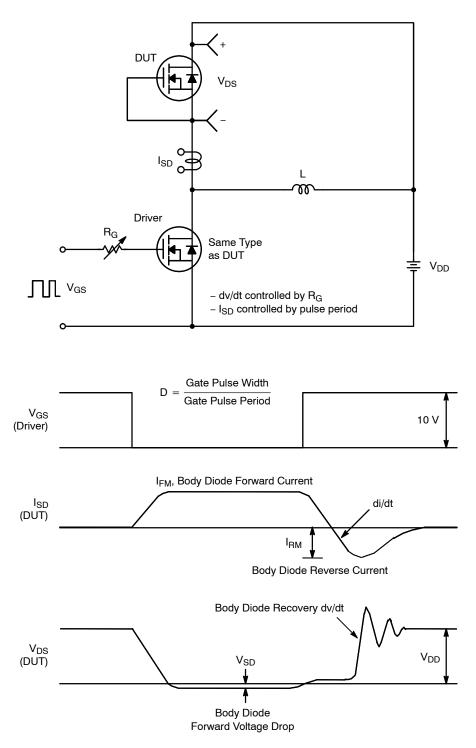
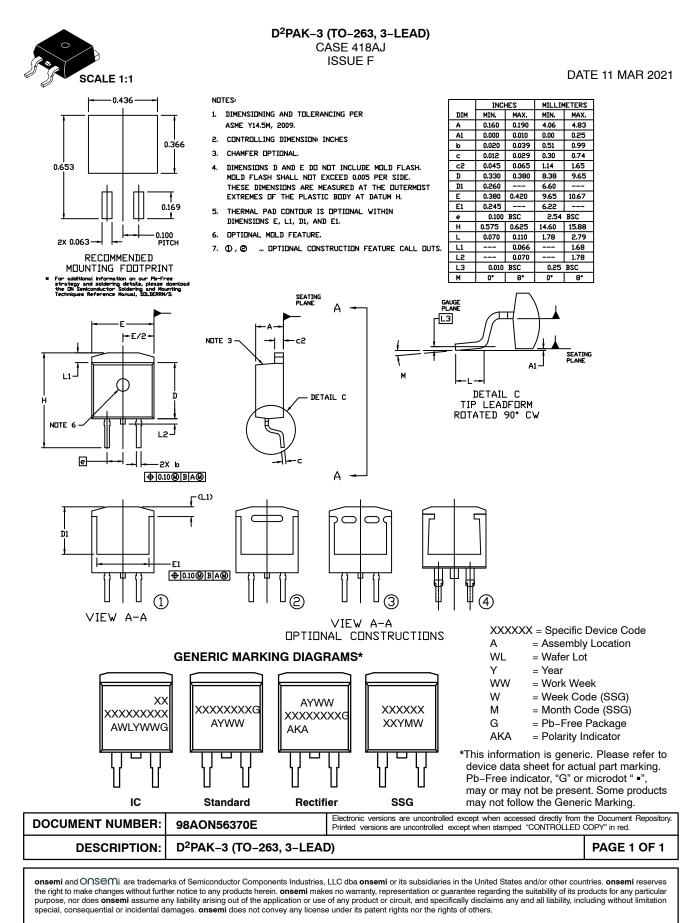


Figure 21. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>